

## Rail-to-rail input/output 20MHz GBP operational amplifiers

### Features

- Low input offset voltage: 1.5mV max
- Rail-to-rail input and output
- Wide bandwidth 20MHz, stable for gain  $\geq 3$
- Low power consumption: 1.1mA maximum
- High output current: 35mA
- Operating from 2.5V to 5.5V
- Low input bias current, 1pA typ
- ESD internal protection  $\geq 5kV$
- Latch-up immunity

### Description

The TSV991/2/4 family of single, dual & quad operational amplifiers offers low voltage operation and rail-to-rail input and output.

This family features an excellent speed/power consumption ratio, offering a 20MHz gain-bandwidth, stable for gain above 3 (100pF capacitive load), while consuming only 1.1mA max at 5V supply voltage. It also features an ultra-low input bias current.

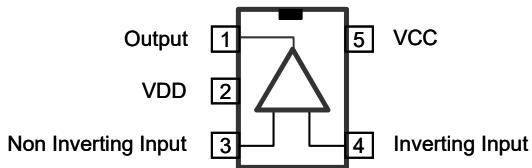
These characteristics make the TSV991/2/4 family ideal for sensor interfaces, battery-supplied and portable applications, as well as active filtering.

### Applications

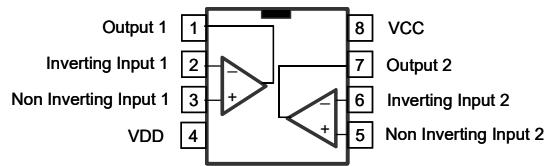
- Battery-powered applications
- Portable devices
- Signal conditioning
- Active filtering
- Medical instrumentation

#### Pin connections (top view)

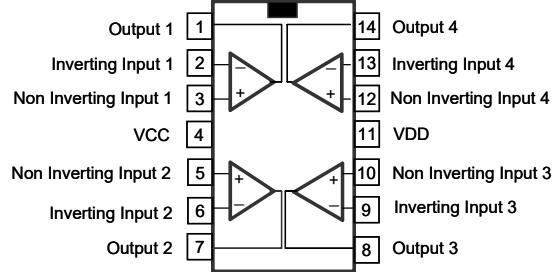
SOT23-5



MSO-8, SO-8



SO-14, TSSOP14



## Contents

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# 1 Absolute maximum ratings & operating conditions

Table 1. Absolute maximum ratings (AMR)

| Symbol     | Parameter   | Value                        | Unit |
|------------|---|------------------------------|------|
| $V_{CC}$   | Supply voltage <sup>(1)</sup>                             | 6                            | V    |
| $V_{id}$   | Differential input voltage <sup>(2)</sup>                 | $\pm V_{CC}$                 | V    |
| $V_{in}$   | Input voltage <sup>(3)</sup>                              | $V_{DD}-0.2$ to $V_{CC}+0.2$ | V    |
| $T_{stg}$  | Storage temperature                                       | -65 to +150                  | °C   |
| $R_{thja}$ | Thermal resistance junction to ambient <sup>(4) (5)</sup> |                              |      |
|            | SOT23-5   | 250                          |      |
|            | SO-8  | 125                          |      |
|            | MiniSO-8  | 190                          |      |
|            | SO-14   | 103                          |      |
|            | TSSOP14   | 100                          |      |
| $R_{thjc}$ | Thermal resistance junction to case                       |                              |      |
|            | SOT23-5   | 81                           |      |
|            | SO-8  | 40                           |      |
|            | MiniSO8   | 39                           |      |
|            | SO14  | 31                           |      |
|            | TSSOP14   | 32                           |      |
| $T_j$      | Maximum junction temperature                              | 150                          | °C   |
| ESD        | HBM: human body model <sup>(6)</sup>                      | 5                            | kV   |
|            | MM: machine model <sup>(7)</sup>                          | 400                          | V    |
|            | CDM: charged device model <sup>(8)</sup>                  |                              |      |
|            | SOT23-5, SO-8, MSO8, SO14                                 | 1500                         | V    |
|            | TSSOP14   | 750                          |      |
|            | Latch-up immunity   | 200                          | mA   |

1. Value with respect to  $V_{DD}$  pin.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3.  $V_{CC}-V_{in}$  must not exceed 6V.
4. Short-circuits can cause excessive heating and destructive dissipation.
5.  $R_{th}$  are typical values.
6. Human body model: 100pF discharged through a 1.5kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
7. Machine model: 200pF is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor  $< 5\Omega$ ), done for all couples of pin combinations with other pins floating.
8. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

**Table 2. Operating conditions**

| Symbol     | Parameter                            | Value                          | Unit |
|------------|--------------------------------------|--------------------------------|------|
| $V_{CC}$   | Supply voltage                       | 2.5 to 5.5                     | V    |
| $V_{icm}$  | Common mode input voltage range      | $V_{DD} -0.1$ to $V_{CC} +0.1$ | V    |
| $T_{oper}$ | Operating free air temperature range | -40 to +125                    | °C   |

## 2 Electrical characteristics

**Table 3. Electrical characteristics at  $V_{CC} = +2.5V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25^\circ C$ ,  $R_L$  connected to  $V_{CC}/2$  (unless otherwise specified)**

| Symbol                | Parameter  | Conditions  | Min. | Typ.     | Max.      | Unit                   |
|-----------------------|--|---|------|----------|-----------|------------------------|
| <b>DC performance</b> |  |   |      |          |           |                        |
| $V_{io}$              | Offset voltage<br>TSV99x   |   | -    | 0.1      | 4.5       | mV                     |
|                       |  | $T_{min} < T_{op} < T_{max}$  | -    | -        | 7.5       |                        |
|                       | TSV99xA  |   | -    | -        | 1.5       |                        |
|                       |  | $T_{min} < T_{op} < T_{max}$  | -    | -        | 3         |                        |
| $DV_{io}$             | Input offset voltage drift   |   | -    | 2        | -         | $\mu V/^\circ C$       |
| $I_{io}$              | Input offset current <sup>(1)</sup><br>( $V_{out} = V_{CC}/2$ )        |   | -    | 1        | 10        | pA                     |
| $I_{ib}$              | Input bias current <sup>(1)</sup><br>( $V_{out} = V_{CC}/2$ )          |   | -    | 1        | 10        | pA                     |
| CMR                   | Common mode rejection ratio<br>$20 \log (\Delta V_{ic}/\Delta V_{io})$ | 0V to 2.5V, $V_{out} = 1.25V$   | 58   | 75       | -         | dB                     |
| $A_{vd}$              | Large signal voltage gain  | $R_L = 10k\Omega$ $V_{out} = 0.5V$ to 2V  | 80   | 89       | -         | dB                     |
| $V_{CC}-V_{OH}$       | High level output voltage  | $R_L = 10k\Omega$<br>$R_L = 600\Omega$  |      | 15<br>45 | 40<br>150 | mV                     |
| $V_{OL}$              | Low level output voltage   | $R_L = 10k\Omega$<br>$R_L = 600\Omega$  | -    | 15<br>45 | 40<br>150 | mV                     |
| $I_{out}$             | $I_{sink}$   | $V_o = 2.5V$  | 18   | 32       | -         | mA                     |
|                       |  | $T_{min} < T_{amb} < T_{max}$   | 16   | -        | -         |                        |
|                       | $I_{source}$   | $V_o = 0V$  | 18   | 35       | -         |                        |
|                       |  | $T_{min} < T_{amb} < T_{max}$   | 16   | -        | -         |                        |
| $I_{CC}$              | Supply current (per operator)  | No load, $V_{out}=V_{CC}/2$   | -    | 0.78     | 1.1       | mA                     |
|                       |  | $T_{min} < T_{op} < T_{max}$  | -    | -        | 1.1       |                        |
| <b>AC performance</b> |  |   |      |          |           |                        |
| GBP                   | Gain bandwidth product   | $R_L = 2k\Omega$ , $C_L = 100pF$ , $f = 100kHz$   | -    | 20       | -         | MHz                    |
| $\phi m$              | Phase margin   | $R_L = 2k\Omega$ , $C_L = 100pF$ , $G=5$ ,<br>$f=100kHz$  | -    | 60       | -         | Degrees                |
| $G_m$                 | Gain margin  | $R_L = 2k\Omega$ , $C_L = 100pF$ , $\phi m=40^\circ$  | -    | 2.5      | -         | dB                     |
| SR                    | Slew rate  | $R_L = 2k\Omega$ , $C_L = 100pF$  | -    | 10       | -         | V/ $\mu s$             |
| $e_n$                 | Equivalent input noise voltage   | $f=10kHz$   | -    | 21       | -         | $\frac{nV}{\sqrt{Hz}}$ |
| THD+ $e_n$            | Total harmonic distortion  | $G=1$ , $f=1kHz$ , $R_L=2k\Omega$ ,<br>$BW=22kHz$ , $V_{icm}=(V_{cc}+1)/2$ ,<br>$V_{out}=1.1V_{pp}$ | -    | 0.0017   | -         | %                      |

1. Guaranteed by design.

**Table 4. Electrical characteristics at  $V_{CC} = +3.3V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25^\circ C$ ,  $R_L$  connected to  $V_{CC}/2$  (unless otherwise specified)**

| Symbol                | Parameter  | Conditions  | Min.                         | Typ.     | Max.      | Unit                   |    |
|-----------------------|--|---|------------------------------|----------|-----------|------------------------|----|
| <b>DC performance</b> |  |   |                              |          |           |                        |    |
| $V_{io}$              | Offset voltage<br>TSV99x   |   | -                            | 0.1      | 4.5       | mV                     |    |
|                       |  | $T_{min} < T_{op} < T_{max}$  | -                            | -        | 7.5       |                        |    |
|                       | TSV99xA  |   | -                            | -        | 1.5       |                        |    |
|                       |  | $T_{min} < T_{op} < T_{max}$  | -                            | -        | 3         |                        |    |
| $DV_{io}$             | Input offset voltage drift   |   | -                            | 2        | -         | $\mu V/^\circ C$       |    |
| $I_{io}$              | Input offset current <sup>(1)</sup>                                    |   | -                            | 1        | 10        | pA                     |    |
| $I_{ib}$              | Input bias current <sup>(1)</sup>                                      |   | -                            | 1        | 10        | pA                     |    |
| CMR                   | Common mode rejection ratio<br>$20 \log (\Delta V_{ic}/\Delta V_{io})$ | 0V to 3.3V, $V_{out} = 1.65V$   | 60                           | 78       | -         | dB                     |    |
| $A_{vd}$              | Large signal voltage gain  | $R_L = 10k\Omega$ $V_{out} = 0.5V$ to $2.8V$  | 80                           | 90       | -         | dB                     |    |
| $V_{CC}-V_{OH}$       | High level output voltage  | $R_L = 10k\Omega$<br>$R_L = 600\Omega$  |                              | 15<br>45 | 40<br>150 | mV                     |    |
| $V_{OL}$              | Low level output voltage   | $R_L = 10k\Omega$<br>$R_L = 600\Omega$  | -                            | 15<br>45 | 40<br>150 | mV                     |    |
| $I_{out}$             | $I_{sink}$   | $V_o = 3.3V$  | 18                           | 32       | -         | mA                     |    |
|                       |  | $T_{min} < T_{amb} < T_{max}$   | 16                           | -        | -         |                        |    |
|                       | $I_{source}$   | $V_o = 0V$  | 18                           | 35       | -         |                        |    |
|                       |  | $T_{min} < T_{amb} < T_{max}$   | 16                           | -        | -         |                        |    |
| $I_{CC}$              | Supply current (per operator)  |   | No load, $V_{out}=V_{CC}/2$  | -        | 0.8       | 1.1                    | mA |
|                       |  |   | $T_{min} < T_{op} < T_{max}$ | -        | -         | 1.1                    |    |
| <b>AC performance</b> |  |   |                              |          |           |                        |    |
| GBP                   | Gain bandwidth product   | $R_L = 2k\Omega$ $C_L = 100pF$ , $f = 100kHz$   | -                            | 20       | -         | MHz                    |    |
| $\phi_m$              | Phase margin   | $R_L = 2k\Omega$ $C_L = 100pF$ , $G=5$  | -                            | 60       | -         | Degrees                |    |
| $G_m$                 | Gain margin  | $R_L = 2k\Omega$ $C_L = 100pF$ ,<br>$f = 100kHz$ , $\phi_m=40^\circ$                                | -                            | 2.5      | -         | dB                     |    |
| SR                    | Slew rate  | $R_L = 2k\Omega$ $C_L = 100pF$ , $f = 100kHz$   | -                            | 10       | -         | $V/\mu s$              |    |
| $e_n$                 | Equivalent input noise voltage   | $f=10kHz$   | -                            | 21       | -         | $\frac{nV}{\sqrt{Hz}}$ |    |
| THD+ $e_n$            | Total harmonic distortion  | $G=1$ , $f=1kHz$ , $R_L=2k\Omega$ ,<br>$BW=22kHz$ , $V_{icm}=(V_{CC}+1)/2$ ,<br>$V_{out}=1.9V_{pp}$ | -                            | 0.001    | -         | %                      |    |

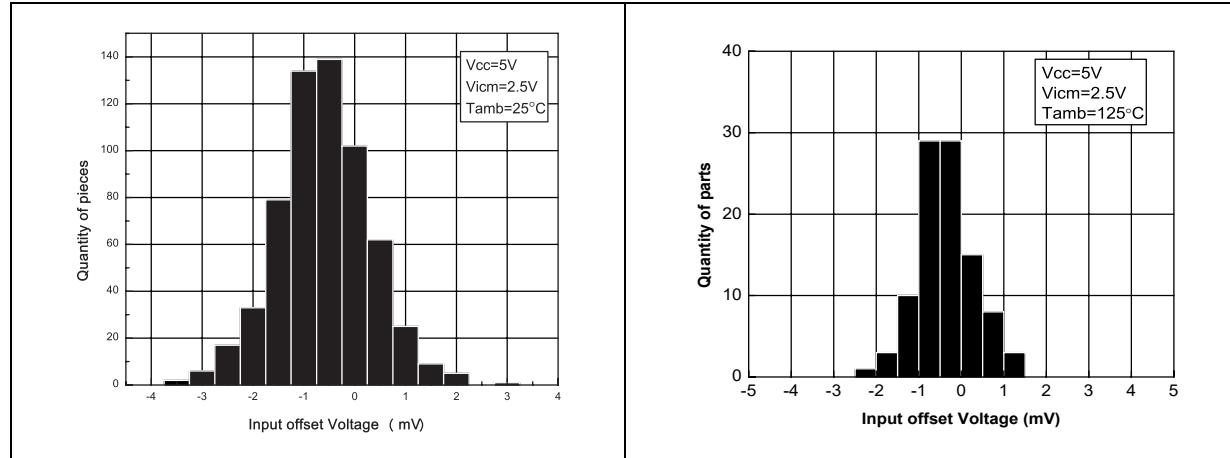
1. Guaranteed by design.

**Table 5. Electrical characteristics at  $V_{CC} = +5V$ ,  $V_{DD} = 0V$ ,  $V_{icm} = V_{CC}/2$ ,  $T_{amb} = 25^\circ C$ ,  $R_L$  connected to  $V_{CC}/2$  (unless otherwise specified)**

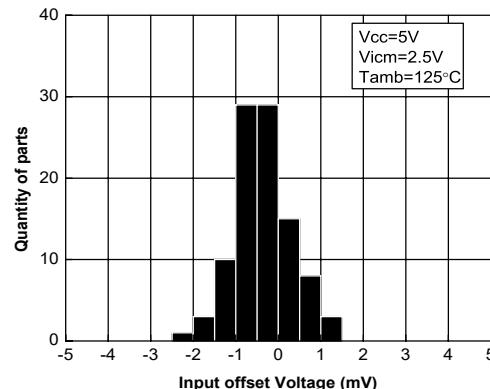
| Symbol                | Parameter   | Conditions   | Min. | Typ.     | Max.      | Unit            |
|-----------------------|---|--|------|----------|-----------|-----------------|
| <b>DC performance</b> |   |  |      |          |           |                 |
| $V_{io}$              | Offset voltage<br>TSV99x  |  | -    | 0.1      | 4.5       | mV              |
|                       |   | $T_{min} < T_{op} < T_{max}$   | -    | -        | 7.5       |                 |
|                       | TSV99xA   |  | -    | -        | 1.5       |                 |
|                       |   | $T_{min} < T_{op} < T_{max}$   | -    | -        | 3         |                 |
| $DV_{io}$             | Input offset voltage drift  |  | -    | 2        | -         | $\mu V^\circ C$ |
| $I_{io}$              | Input offset current <sup>(1)</sup>                                       |  | -    | 1        | 10        | pA              |
| $I_{ib}$              | Input bias current <sup>(1)</sup>   |  | -    | 1        | 10        | pA              |
| CMR                   | Common mode rejection ratio<br>$20 \log (\Delta V_{ic}/\Delta V_{io})$    | $0V$ to $5V$ , $V_{out} = 2.5V$  | 62   | 82       | -         | dB              |
| SVR                   | Supply voltage rejection ratio<br>$20 \log (\Delta V_{cc}/\Delta V_{io})$ | $V_{CC} = 2.5$ to $5V$   | 70   | 86       | -         | dB              |
| $A_{vd}$              | Large signal voltage gain   | $R_L=10k\Omega$ $V_{out}=0.5V$ to $4.5V$   | 80   | 91       | -         | dB              |
| $V_{CC}-V_{OH}$       | High level output voltage   | $R_L = 10k\Omega$<br>$R_L = 600\Omega$   |      | 15<br>45 | 40<br>150 | mV              |
| $V_{OL}$              | Low level output voltage  | $R_L = 10k\Omega$<br>$R_L = 600\Omega$   | -    | 15<br>45 | 40<br>150 | mV              |
| $I_{out}$             | $I_{sink}$  | $V_o = 5V$   | 18   | 32       | -         | mA              |
|                       |   | $T_{min} < T_{amb} < T_{max}$  | 16   | -        | -         |                 |
|                       | $I_{source}$  | $V_o = 0V$   | 18   | 35       | -         |                 |
|                       |   | $T_{min} < T_{amb} < T_{max}$  | 16   | -        | -         |                 |
| $I_{CC}$              | Supply current (per operator)   | No load, $V_{out}=2.5V$  | -    | 0.82     | 1.1       | mA              |
|                       |   | $T_{min} < T_{op} < T_{max}$   | -    | -        | 1.1       |                 |
| <b>AC performance</b> |   |  |      |          |           |                 |
| GBP                   | Gain bandwidth product  | $R_L = 2k\Omega$ $C_L = 100pF$ ,<br>$f = 100kHz$   | -    | 20       | -         | MHz             |
| $\phi_m$              | Phase margin  | $R_L = 2k\Omega$ $C_L = 100pF$ , $G=5$   | -    | 60       | -         | Degrees         |
| $G_m$                 | Gain margin   | $R_L = 2k\Omega$ $C_L=100pF$ , $\phi_m=40^\circ$   | -    | 2.5      | -         | dB              |
| SR                    | Slew rate   | $R_L = 2k\Omega$ $C_L = 100pF$   | -    | 10       | -         | $V/\mu s$       |
| $e_n$                 | Equivalent input noise voltage  | $f=10kHz$  | -    | 21       | -         | $nV/\sqrt{Hz}$  |
| THD+ $e_n$            | Total harmonic distortion   | $G=1$ , $f=1kHz$ , $R_L=2k\Omega$ ,<br>$BW=22kHz$ , $Vicm=(V_{cc}+1)/2$ ,<br>$V_{out}=3.6V_{pp}$ | -    | 0.0007   | -         | %               |

1. Guaranteed by design.

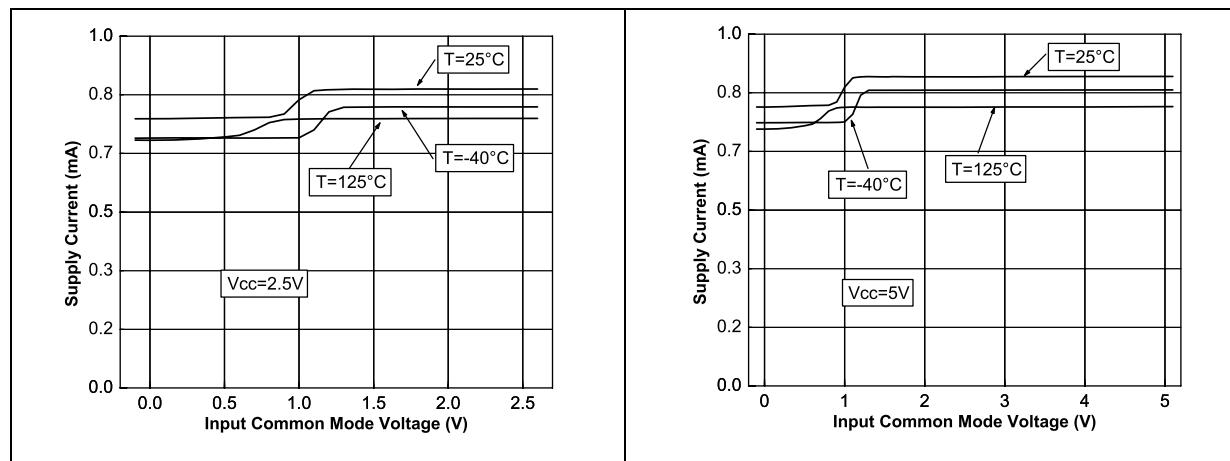
**Figure 1. Input offset voltage distribution at  $T=25^{\circ}\text{C}$**



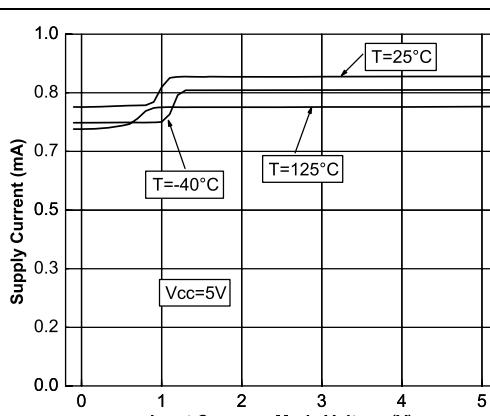
**Figure 2. Input offset voltage distribution at  $T=125^{\circ}\text{C}$**



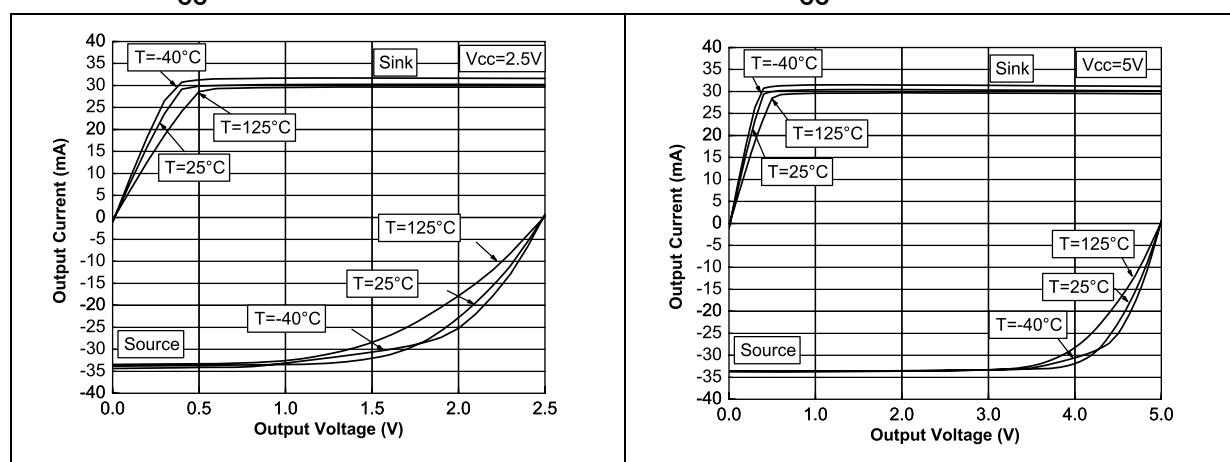
**Figure 3. Supply current vs. input common mode voltage at  $V_{CC}=2.5\text{V}$**



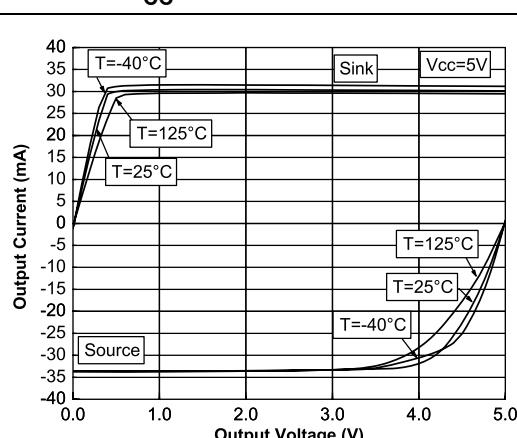
**Figure 4. Supply current vs. input common mode voltage at  $V_{CC}=5\text{V}$**



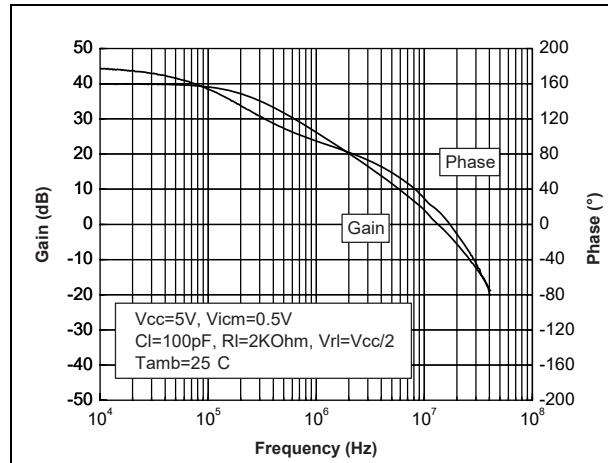
**Figure 5. Output current vs. output voltage at  $V_{CC}=2.5\text{V}$**



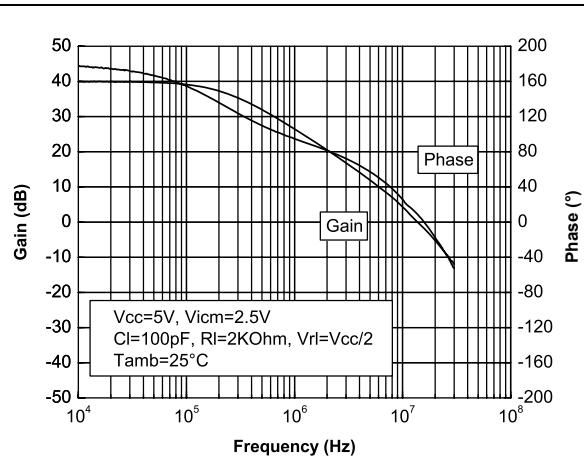
**Figure 6. Output current vs. output voltage at  $V_{CC}=5\text{V}$**



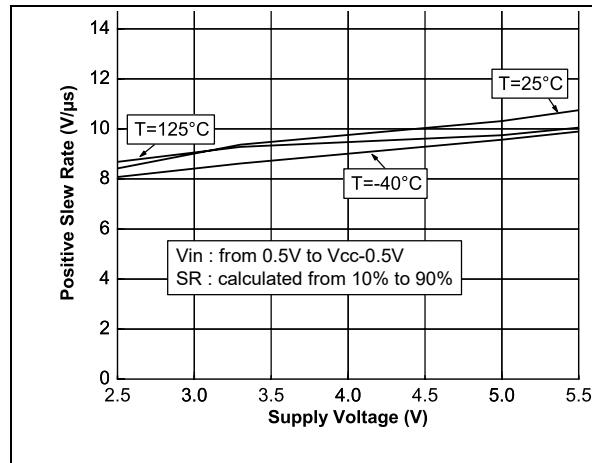
**Figure 7. Voltage gain and phase vs frequency at  $V_{CC}=5V$  and  $V_{icm}=0.5V$**



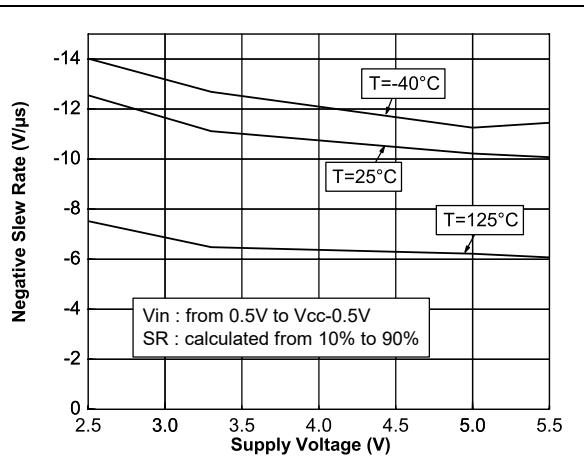
**Figure 8. Voltage gain and phase vs frequency at  $V_{CC}=5V$  and  $V_{icm}=2.5V$**



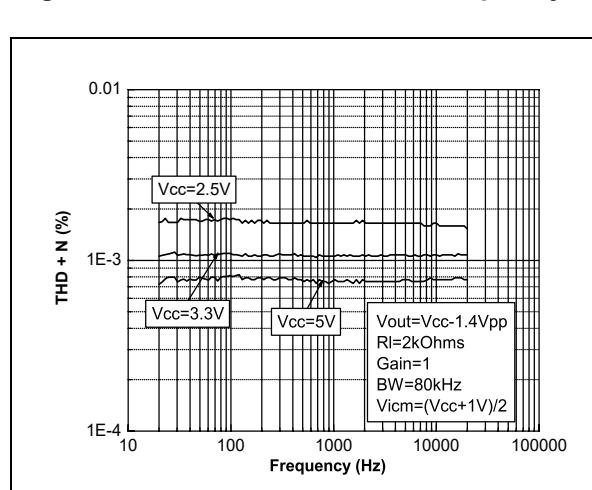
**Figure 9. Positive slew rate**



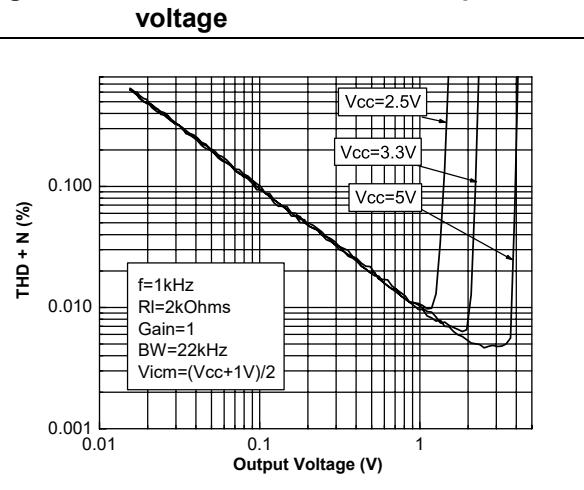
**Figure 10. Negative slew rate**

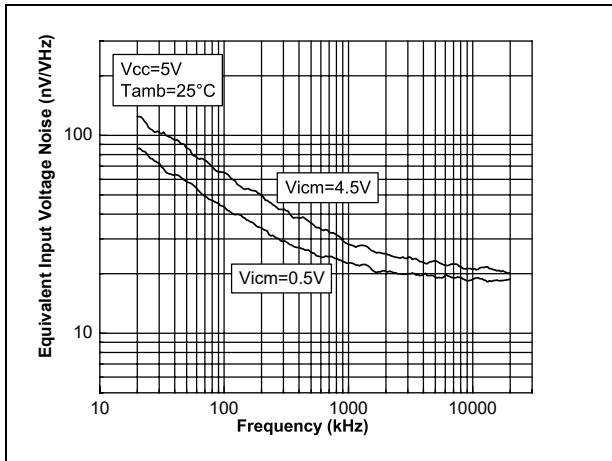


**Figure 11. Distortion + noise vs. frequency**



**Figure 12. Distortion + noise vs. output voltage**



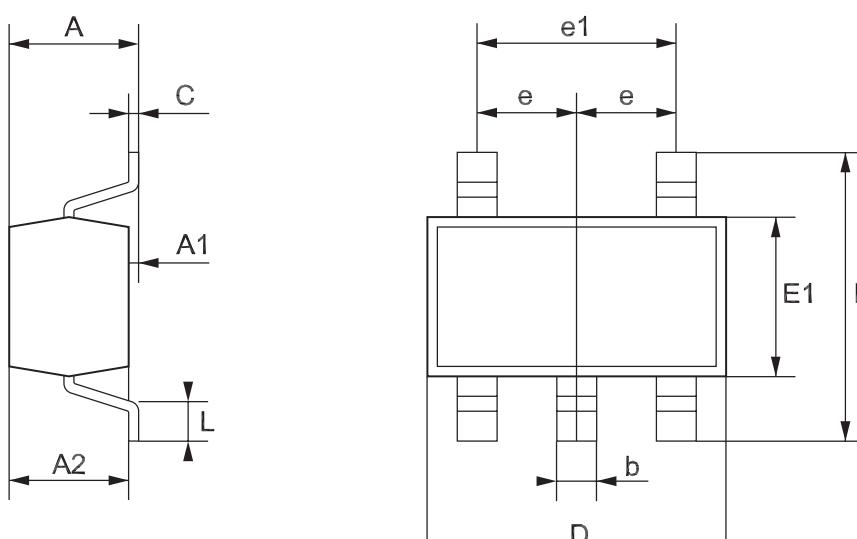
**Figure 13. Noise vs. frequency**

### 3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

**Figure 14. SOT23-5 package**

| Ref. | Dimensions  |      |      |       |      |       |
|------|-------------|------|------|-------|------|-------|
|      | Millimeters |      |      | Mils  |      |       |
|      | Min.        | Typ. | Max. | Min.  | Typ. | Max.  |
| A    | 0.90        |      | 1.45 | 35.4  |      | 57.1  |
| A1   | 0.00        |      | 0.15 | 0.00  |      | 5.9   |
| A2   | 0.90        |      | 1.30 | 35.4  |      | 51.2  |
| b    | 0.35        |      | 0.50 | 13.7  |      | 19.7  |
| C    | 0.09        |      | 0.20 | 3.5   |      | 7.8   |
| D    | 2.80        |      | 3.00 | 110.2 |      | 118.1 |
| E    | 2.60        |      | 3.00 | 102.3 |      | 118.1 |
| E1   | 1.50        |      | 1.75 | 59.0  |      | 68.8  |
| e    |             | 0.95 |      |       | 37.4 |       |
| e1   |             | 1.9  |      |       | 74.8 |       |
| L    | 0.35        |      | 0.55 | 13.7  |      | 21.6  |



The diagram illustrates the physical dimensions of the SOT23-5 package. The top view shows the overall footprint with width D and height E. The side view provides a detailed look at the lead spacing (e), lead thickness (e1), body height (E), and lead length (L). Other dimensions include A (body width), A1 (lead thickness), A2 (lead spacing), and C (lead pitch).

Figure 15. MiniSO-8 package

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    |             |      | 1.1  |        |       | 0.043 |
| A1   | 0.05        | 0.10 | 0.15 | 0.002  | 0.004 | 0.006 |
| A2   | 0.78        | 0.86 | 0.94 | 0.031  | 0.034 | 0.037 |
| b    | 0.25        | 0.33 | 0.40 | 0.010  | 0.013 | 0.016 |
| c    | 0.13        | 0.18 | 0.23 | 0.005  | 0.007 | 0.009 |
| D    | 2.90        | 3.00 | 3.10 | 0.114  | 0.118 | 0.122 |
| E    | 4.75        | 4.90 | 5.05 | 0.187  | 0.193 | 0.199 |
| E1   | 2.90        | 3.00 | 3.10 | 0.114  | 0.118 | 0.122 |
| e    |             | 0.65 |      |        | 0.026 |       |
| K    | 0°          |      | 6°   | 0°     |       | 6°    |
| L    | 0.40        | 0.55 | 0.70 | 0.016  | 0.022 | 0.028 |
| L1   |             |      | 0.10 |        |       | 0.04  |

The figure contains three technical drawings of the MiniSO-8 package. The top drawing shows a side cross-section with dimensions: A (height), A1 (lead thickness), A2 (lead width), b (lead pitch), c (lead height), D (body width), E (body length), k (lead tip angle), L (lead lead-in length), L1 (lead lead-out length), and a callout for '0.25 mm .010 inch GAGE PLANE' at the seating plane. The middle drawing shows a top-down view of the package with pins numbered 1 through 8. Pin 1 is identified by a dot on the front-left corner. The bottom drawing shows a side view of the package with dimensions A, A1, A2, b, c, D, and E labeled.

Figure 16. SO-8 package

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    | 1.35        |      | 1.75 | 0.053  |       | 0.069 |
| A1   | 0.10        |      | 0.25 | 0.04   |       | 0.010 |
| A2   | 1.10        |      | 1.65 | 0.043  |       | 0.065 |
| B    | 0.33        |      | 0.51 | 0.013  |       | 0.020 |
| C    | 0.19        |      | 0.25 | 0.007  |       | 0.010 |
| D    | 4.80        |      | 5.00 | 0.189  |       | 0.197 |
| E    | 3.80        |      | 4.00 | 0.150  |       | 0.157 |
| e    |             | 1.27 |      |        | 0.050 |       |
| H    | 5.80        |      | 6.20 | 0.228  |       | 0.244 |
| h    | 0.25        |      | 0.50 | 0.010  |       | 0.020 |
| L    | 0.40        |      | 1.27 | 0.016  |       | 0.050 |
| k    | 8° (max.)   |      |      |        |       |       |
| ddd  |             |      | 0.1  |        |       | 0.04  |

The figure contains three technical drawings of an SO-8 package. The top drawing shows a top-down view with pins numbered 1 through 8. Dimensions include D (width), E (height), H (total height), and e (pin pitch). The middle drawing shows a side cross-section with dimensions A, A1, A2, B, C, and L. It also indicates a lead angle of h x 45°. The bottom drawing shows a bottom cross-section with a seating plane labeled 'C' and a gage plane labeled '0.25 mm GAGE PLANE'. The angle 'k' is shown between the seating plane and the gage plane.

Figure 17. TSSOP14 package

| Ref. | Dimensions  |          |      |        |            |        |
|------|-------------|----------|------|--------|------------|--------|
|      | Millimeters |          |      | Inches |            |        |
|      | Min.        | Typ.     | Max. | Min.   | Typ.       | Max.   |
| A    |             |          | 1.2  |        |            | 0.047  |
| A1   | 0.05        |          | 0.15 | 0.002  | 0.004      | 0.006  |
| A2   | 0.8         | 1        | 1.05 | 0.031  | 0.039      | 0.041  |
| b    | 0.19        |          | 0.30 | 0.007  |            | 0.012  |
| c    | 0.09        |          | 0.20 | 0.004  |            | 0.0089 |
| D    | 4.9         | 5        | 5.1  | 0.193  | 0.197      | 0.201  |
| E    | 6.2         | 6.4      | 6.6  | 0.244  | 0.252      | 0.260  |
| E1   | 4.3         | 4.4      | 4.48 | 0.169  | 0.173      | 0.176  |
| e    |             | 0.65 BSC |      |        | 0.0256 BSC |        |
| K    | 0°          |          | 8°   | 0°     |            | 8°     |
| L1   | 0.45        | 0.60     | 0.75 | 0.018  | 0.024      | 0.030  |

The figure contains three technical drawings of the TSSOP14 package. The top drawing shows a side cross-section with dimensions A, A2, A1, b, e, and c. The middle drawing shows a top-down view with dimensions D, E1, K, L, and E. The bottom drawing shows a front view with a circle indicating 'PIN 1 IDENTIFICATION' and the number '1' below it.

Figure 18. SO-14 package

| Ref. | Dimensions  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    |             |      | 1.75 |        |       | 0.068 |
| a1   | 0.1         |      | 0.2  | 0.003  |       | 0.007 |
| a2   |             |      | 1.65 |        |       | 0.064 |
| b    | 0.35        |      | 0.46 | 0.013  |       | 0.018 |
| b1   | 0.19        |      | 0.25 | 0.007  |       | 0.010 |
| C    |             | 0.5  |      |        | 0.019 |       |
| c1   | 45° (typ.)  |      |      |        |       |       |
| D    | 8.55        |      | 8.75 | 0.336  |       | 0.344 |
| E    | 5.8         |      | 6.2  | 0.228  |       | 0.244 |
| e    |             | 1.27 |      |        | 0.050 |       |
| e3   |             | 7.62 |      |        | 0.300 |       |
| F    | 3.8         |      | 4.0  | 0.149  |       | 0.157 |
| G    | 4.6         |      | 5.3  | 0.181  |       | 0.208 |
| L    | 0.5         |      | 1.27 | 0.019  |       | 0.050 |
| M    |             |      | 0.68 |        |       | 0.026 |
| S    | 8° (max.)   |      |      |        |       |       |

The technical drawing illustrates the physical dimensions and pinout of an SO-14 package. The top view shows the package body with pins numbered 1 through 14. The side view provides a cross-sectional look at the lead frame, with dimensions L, G, c, c1, s, and H labeled. The bottom view shows the lead frame with pins 1, 7, 8, and 14 labeled, along with dimension M.

## 4 Ordering information

| Part number | Temperature range | Package  | Packing             | Marking |  |
|-------------|-------------------|----------|---------------------|---------|--|
| TSV991ILT   | -40°C to +125°C   | SOT23-5  | Tape & reel         | K130    |  |
| TSV991AILT  |                   |          |                     | K129    |  |
| TSV992IST   |                   | MiniSO-8 |                     | K132    |  |
| TSV992AIST  |                   |          |                     | K135    |  |
| TSV992ID    |                   | SO-8     | Tube or tape & reel | V992I   |  |
| TSV992IDT   |                   |          |                     | V992AI  |  |
| TSV992AID   |                   | TSSOP14  | Tape & reel         | V994I   |  |
| TSV992AIDT  |                   |          |                     | V994AI  |  |
| TSV994IPT   |                   | SO-14    | Tube or tape & reel | V994I   |  |
| TSV994AIPT  |                   |          |                     | V994AI  |  |
| TSV994ID    |                   |          |                     |         |  |
| TSV994IDT   |                   |          |                     |         |  |
| TSV994AID   |                   |          |                     |         |  |
| TSV994AIDT  |                   |          |                     |         |  |

## 5 Revision history

| Date        | Revision | Changes   |
|-------------|----------|---|
| 31-Jul-2006 | 1        | Preliminary data release for product under development. |
| 7-Nov-2006  | 2        | Final version of datasheet.                             |
| 12-Dec-2006 | 3        | Noise and distortion figures added.                     |

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